

# Optimizing the deposition rate and ionized flux fraction by tuning the pulse length in high power impulse magnetron sputtering

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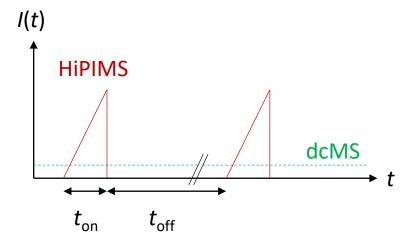


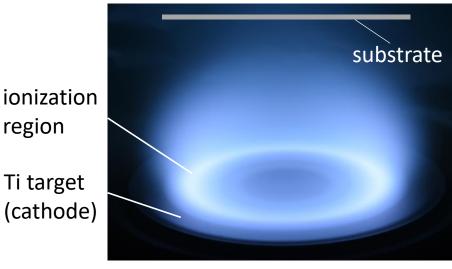






## High power impulse magnetron sputtering



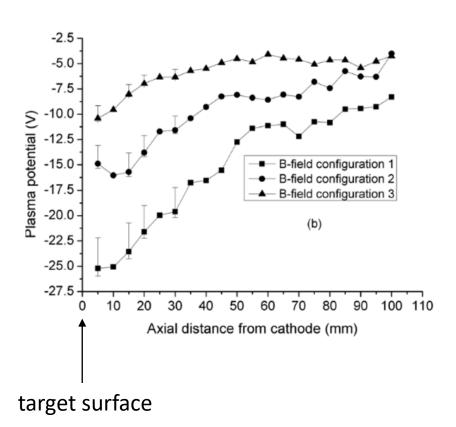


Ar/Ti HiPIMS discharge

- power supplied in pulses with high peak currents
  - high electron density
  - high fraction of target species ions in the flux to the substrate
- improves certain film properties
  - density
  - film-adhesion
  - **//** ...

#### Loss in deposition rate

# Emissive probe measurements of the plasma potential

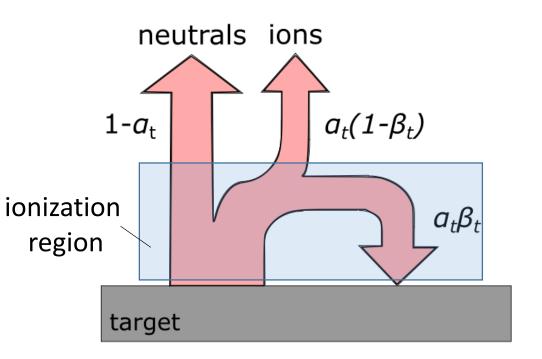


- extended presheat
  - electric field directed towards the target
  - / in the ionization region
- principal cause for the loss in deposition rate
  - In high probability of target species ionization  $\alpha_t$
  - electric field in the ionization region



#### Deposition rate and ionized flux fraction

#### substrate



- material pathways model (Christie, 2005)
- $\blacksquare$  ionization probability of target species  $\alpha_{t}$
- $\overline{\phantom{a}}$  probability of target ion back-attraction  $\theta_{\rm t}$
- deposition rate
  (sputter-rate normalized)

$$F_{\rm dep} = 1 - \alpha_{\rm t} \beta_{\rm t}$$

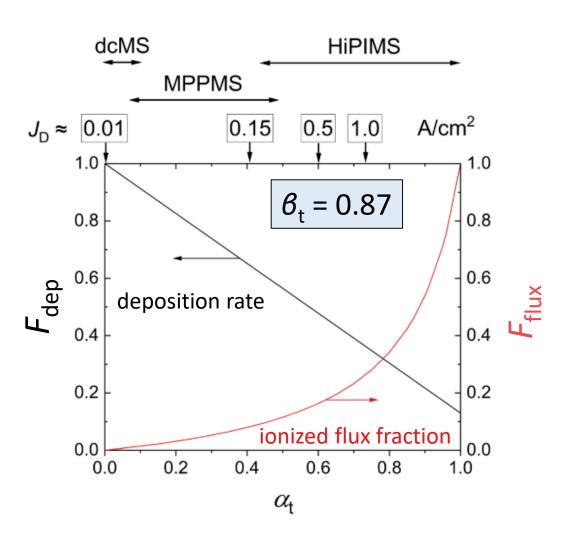
ionized flux fraction:

$$F_{\text{flux}} = \frac{\alpha_{\text{t}}(1-\beta_{\text{t}})}{(1-\alpha_{\text{t}}\beta_{\text{t}})}$$

<u>Goal</u>: Increase deposition rate while not compromising the ionized flux fraction



## Case study I: constant $\theta_{t_i}$ variable $\alpha_t$



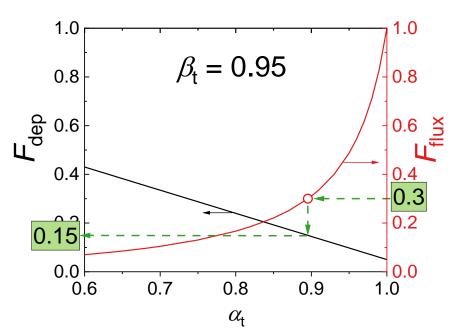
- $\alpha_{t}$  scales with the discharge current
- increased deposition rate is linked to a lower ionized flux fraction

For a constant  $\theta_t$ , it is impossible to Increase the deposition rate without compromising the ionized flux fraction.

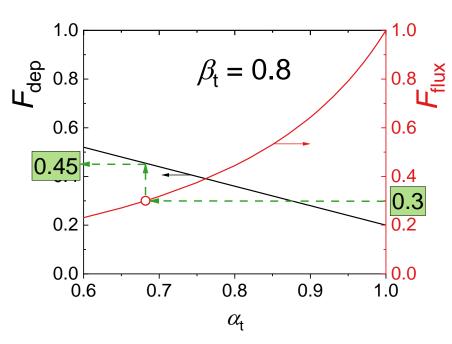


### Case study II: $\theta_{t}$ as a single figure of merit for HiPIMS discharges





#### low back-attraction case

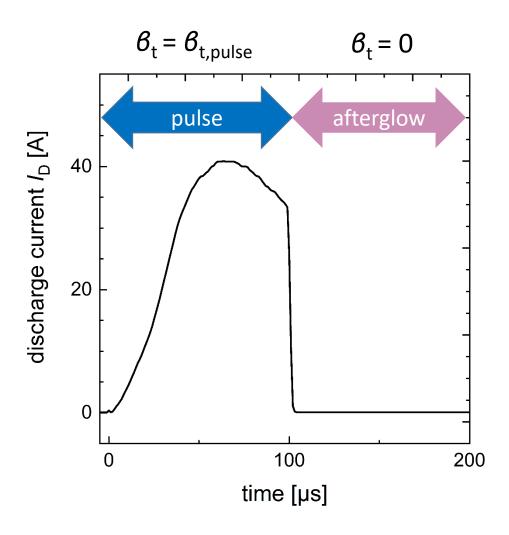


A low target ion back-attraction  $\theta_t$  gives a better combination of  $F_{dep}$  and  $F_{flux}$ 

 $\theta_{t}$  can be used as a *single figure of merit* for a HiPIMS discharge.



#### Making use of the afterglow to lower the ion back-attraction



 $\mathcal{I}_{t}$  is an average value for one period

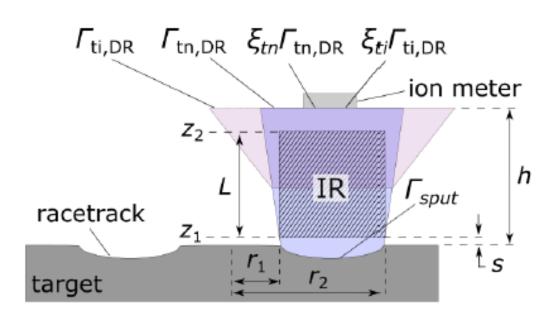
$$\theta_{t}(t) = \begin{cases}
\theta_{t,pulse} & \text{during the pulse} \\
0 & \text{in the afterglow}
\end{cases}$$

increase the relative contribution from the afterglow to the deposition rate

Idea: Shortening the pulse length while keeping the peak discharge current high.



#### The ionization region model (IRM)

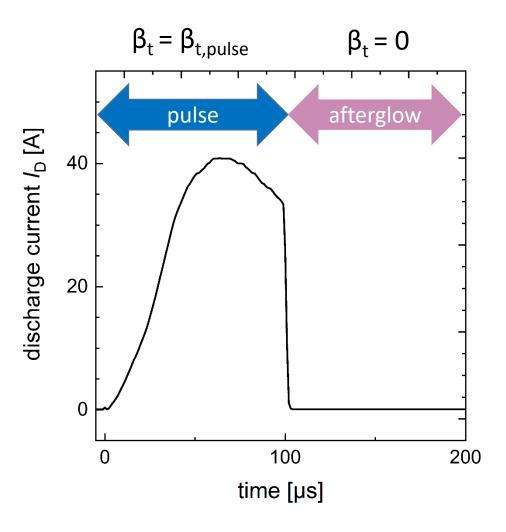


- time-dependent global discharge model of the ionization region of a HiPIMS discharge
- well-knowns: pressure, gas, target, geometry, collision rate coefficients, diffusion rates
- unknowns:
  - lacktriangle target ion back-attraction during pulse  $eta_{\rm t,pulse}$
  - electric potential drop over the IR:  $V_{IR}$
- requires experimental input
  - *U*(t) and *I*(t)
  - ionized flux fraction F<sub>flux</sub>

IRM provides  $\alpha_t$  and  $\theta_t$  of an experimental discharge



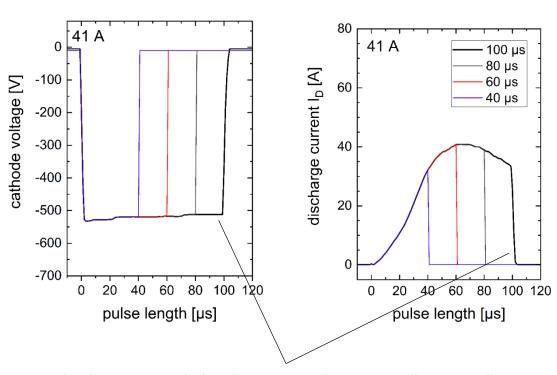
#### Modelling the afterglow



modifications to existing IRM :

$$\theta_{t}(t) = \begin{cases}
\theta_{t,pulse} & \text{during pulse} \\
0 & \text{in the afterglow}
\end{cases}$$

#### **Experimental input to the IRM**



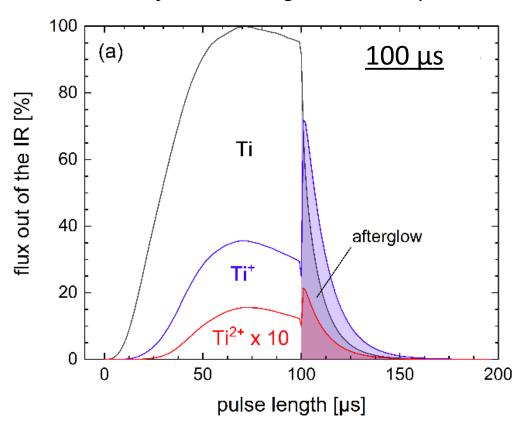
Black: Original discharge with 100 µs-long pulse

- Original discharge: 100 μs-long pulse (Haji. 2019)
  - ✓ 4" Ti target
  - 300 W average power
  - 41 A (and 76 A) peak discharge current
- Virtually cutting the pulses short  $t_{\text{pulse}} = 100 \mu \text{s}$ , 80 μs, 60 μs, 40 μs
- Discharge evolution follows the experimental one until the pulse is virtually switched off
- Discharge current at end of pulse remains (close to) constant



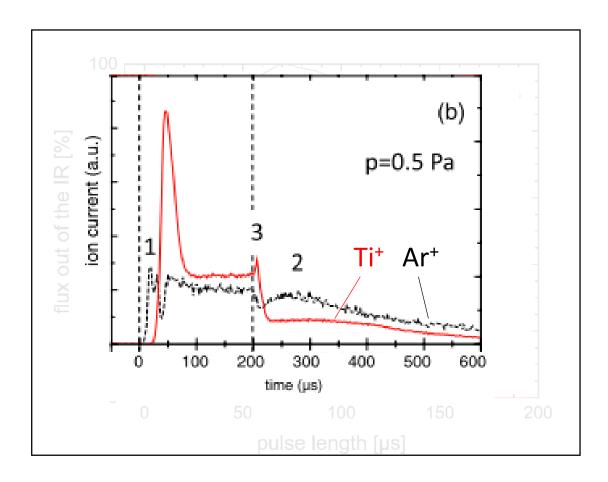
#### Result for a 100 µs-long pulse

flux of film-forming material (Ti, Ti<sup>+</sup>, Ti<sup>2+</sup>) out of the IR during one HiPIMS pulse



- jump in ion flux when pulse is switched off
  - loss of ion back-attraction
  - ion production ceases slowly only

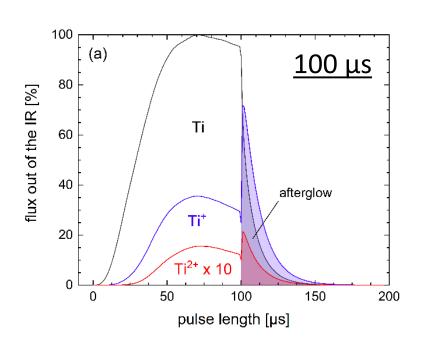
#### Result for a 100 µs-long pulse

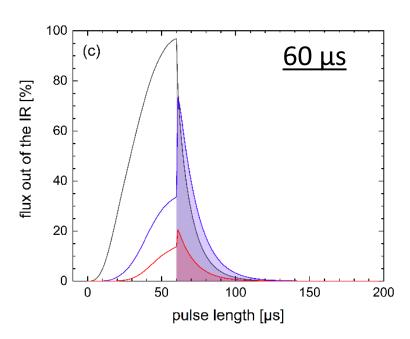


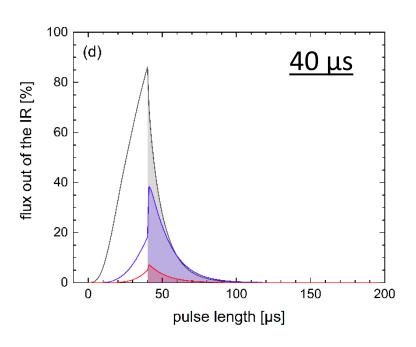
- jump in ion flux when pulse is switched off
  - loss of ion back-attraction
  - ion production ceases slowly only
- **Experimental support by Breilmann** *et al.* 
  - time-resolved mass spectrometry
  - peak in ion current after end of pulse
  - explained by acceleration mechanism from jump in plasma potential



#### **Shortening the pulses**







flux of film-forming material out of the IR for different pulse lengths

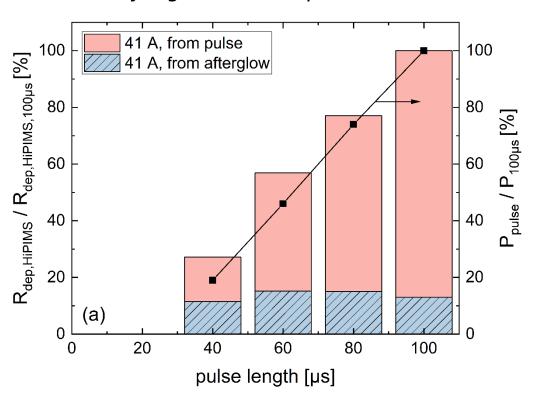
- lower flux during the pulse
- constant flux during the afterglow

Growing contribution to the flux out of the IR from the afterglow with shorter pulses.



#### **Contributions to the deposition rate**

# Contribution from pulse and afterglow to the deposition rate



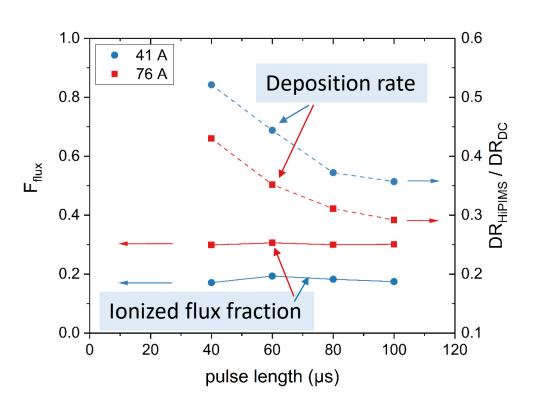
#### Shorter pulses give...

- growing contribution from afterglow
- faster decrease in power/pulse compared to deposition rate

Gain in deposition rate is possible for constant average power (frequency to be increased)



#### Shorter pulses at constant average power



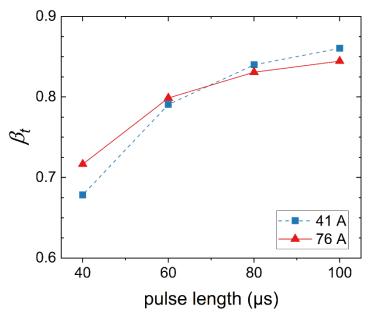
Increasing the frequency to constant average power

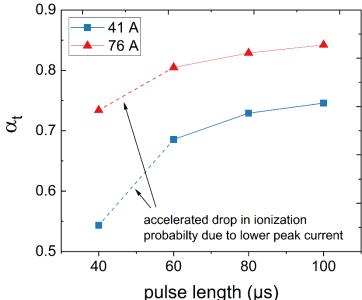
Increase in deposition rate by 40 to 50 % Constant ionized flux fraction

Side note: limit to decreasing the pulse length given by the time to build-up a high n<sub>e</sub> and the typical time for ionization



## Internal discharge parameters $\alpha_t$ and $\beta_t$





#### Shorter pulses

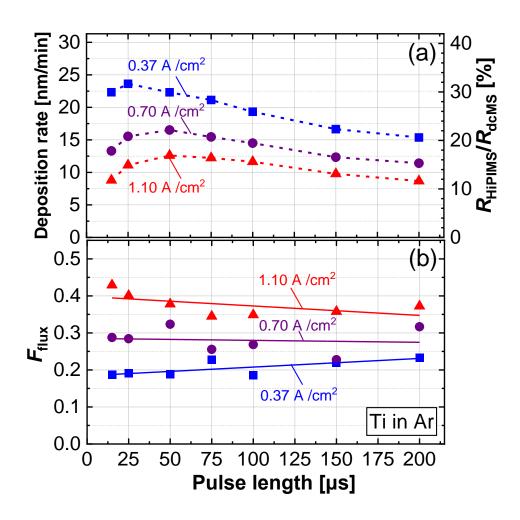
- decrease target ion back-attraction  $\beta_t$  from larger contribution of afterglow to the flux out of the IR
- $\blacksquare$  decrease ionization probability  $\alpha_{t}$ 
  - effect of shorter time for ionization
  - indicates limit for pulse length

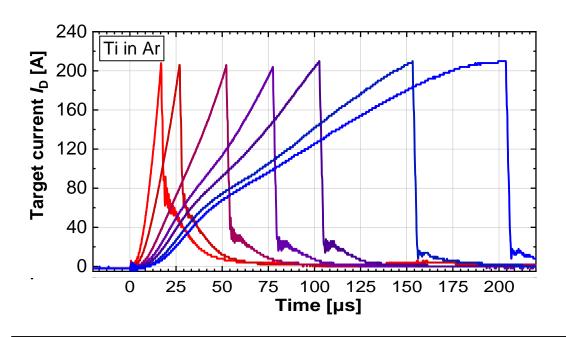
Increasing 
$$F_{\rm dep} = 1 - \alpha_{\rm t} \beta_{\rm t}$$
.

Overall constant  $F_{\rm flux} = \frac{\alpha_{\rm t}(1-\beta_{\rm t})}{(1-\alpha_{\rm t}\beta_{\rm t})}$  for the discharge and the pulse lengths investigated



#### **Experimental verification**





 $6^{\prime\prime}$  circular magnetron with Ti target pulse length between 15 and 200  $\mu s$  peak discharge currents between 0.37 and 1.1 A/cm²

Experiments verify the IRM findings.



#### **Conclusion and outlook**

- Shortening the pulse lengths while keeping the peak discharge current high ...
  - can partially recover the loss in deposition rate between dcMS and HiPIMS
  - gives a constant ionized flux fraction for the discharges and the pulse lengths investigated (see Rudolph et al, PSST 29, 05LT01, 2020)
- ✓ Modelling results are supported by experiments (see Shimizu et al, PSST 30, 045006, 2021)



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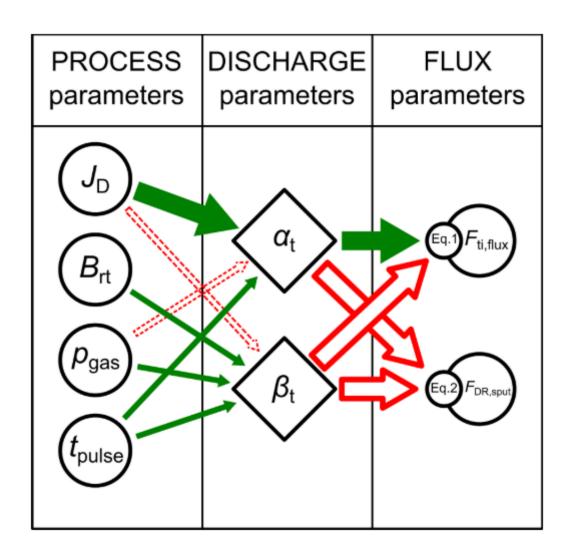
#### **Appendix: HiPIMS optimization scheme**

discharge current

magnetic field strength

working gas pressure

pulse length

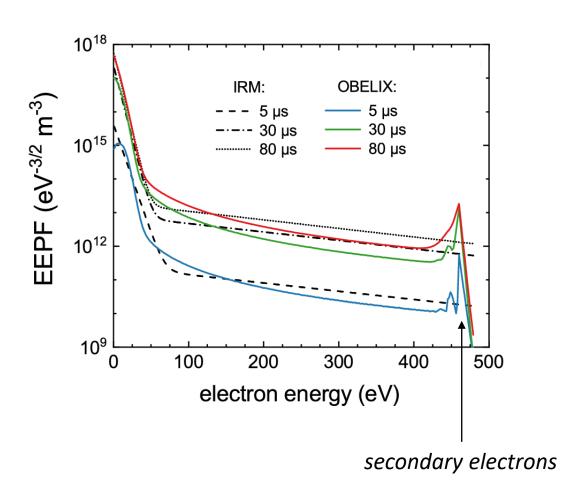


ionized flux fraction

deposition rate



#### **Appendix: EEPF in HiPIMS discharges**



- IRM comparison to OBELIX\*
  - IRM assumes bi-Maxwellian EEDF
  - Obelix solves the Boltzmann eq.
- Comparison shows a good match of the electron energy probability function (EEPF)



Orsay Boltzmann equation for ELectrons coupled with Ionization and eXcited states kinetics (OBELIX)